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## **Materials for Additive Manufacturing Processes**

Guest Editor:

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# **Message from the Guest Editor**

Dear Colleagues,

Research related to additive manufacturing (AM) is rapidly evolving, both in terms of processes and materials. In particular, many papers have been published about processing existing materials, as well as introducing completely new materials specifically designed for additive technologies. These studies have demonstrated that AM processes introduce many possibilities to develop new materials with specific properties.

This Special Issue aims to publish results in the field of materials processed by AM, with special attention on material consolidation, microstructure, and properties.













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### **Editor-in-Chief**

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## **Message from the Editor-in-Chief**

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